

# 32K x 8 Static RAM

## Features

- **High speed**  
— 10 ns
- **Fast  $t_{DOE}$**
- **CMOS for optimum speed/power**
- **Low active power**  
— 467 mW (max, 12 ns “L” version)
- **Low standby power**  
— 0.275 mW (max, “L” version)
- **2V data retention (“L” version only)**
- **Easy memory expansion with  $\overline{CE}$  and  $\overline{OE}$  features**
- **TTL-compatible inputs and outputs**
- **Automatic power-down when deselected**

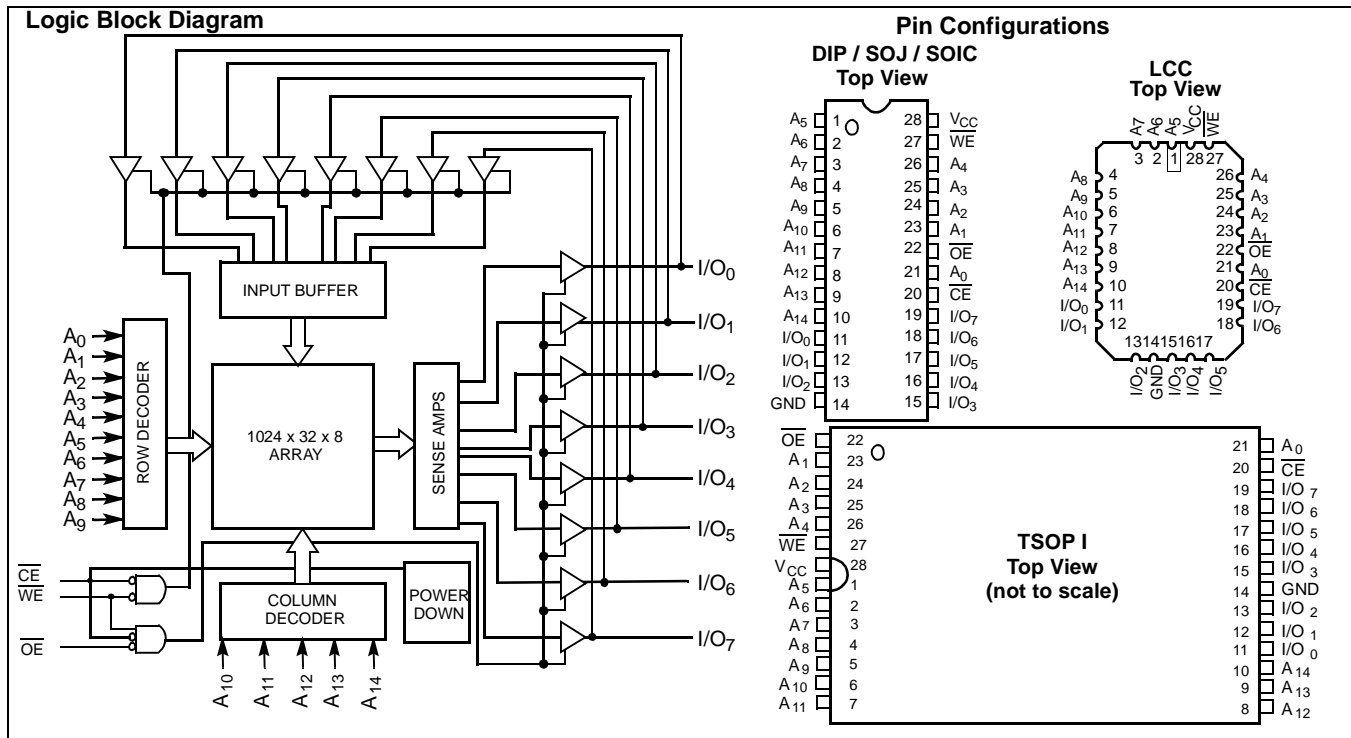
## Functional Description

The CY7C199 is a high-performance CMOS static RAM organized as 32,768 words by 8 bits. Easy memory expansion

is provided by an active LOW Chip Enable ( $\overline{CE}$ ) and active LOW Output Enable ( $\overline{OE}$ ) and three-state drivers. This device has an automatic power-down feature, reducing the power consumption by 81% when deselected. The CY7C199 is in the standard 300-mil-wide DIP, SOJ, and LCC packages.

An active LOW Write Enable signal ( $\overline{WE}$ ) controls the writing/reading operation of the memory. When  $\overline{CE}$  and  $\overline{WE}$  inputs are both LOW, data on the eight data input/output pins ( $I/O_0$  through  $I/O_7$ ) is written into the memory location addressed by the address present on the address pins ( $A_0$  through  $A_{14}$ ). Reading the device is accomplished by selecting the device and enabling the outputs,  $\overline{CE}$  and  $\overline{OE}$  active LOW, while  $\overline{WE}$  remains inactive or HIGH. Under these conditions, the contents of the location addressed by the information on address pins are present on the eight data input/output pins.

The input/output pins remain in a high-impedance state unless the chip is selected, outputs are enabled, and Write Enable ( $\overline{WE}$ ) is HIGH. A die coat is used to improve alpha immunity.



## Selection Guide

	7C199-8	7C199-10	7C199-12	7C199-15	7C199-20	7C199-25	7C199-35	7C199-45	Unit
Maximum Access Time	8	10	12	15	20	25	35	45	ns
Maximum Operating Current	120	110	160	155	150	150	140	140	mA
L		90	90	90	90	80	70		
Maximum CMOS Standby Current	0.5	0.5	10	10	10	10	10	10	mA
L		0.05	0.05	0.05	0.05	0.05	0.05		

Shaded area contains advance information.

**Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature ..... -65°C to +150°C

Ambient Temperature with Power Applied ..... -55°C to +125°C

Supply Voltage to Ground Potential (Pin 28 to Pin 14) ..... -0.5V to +7.0V

 DC Voltage Applied to Outputs in High-Z State<sup>[1]</sup> ..... -0.5V to V<sub>CC</sub> + 0.5V

 DC Input Voltage<sup>[1]</sup> ..... -0.5V to V<sub>CC</sub> + 0.5V

Output Current into Outputs (LOW) ..... 20 mA

Static Discharge Voltage ..... &gt; 2001V (per MIL-STD-883, Method 3015)

Latch-up Current ..... &gt; 200 mA

**Operating Range**

Range	Ambient Temperature <sup>[2]</sup>	V <sub>CC</sub>
Commercial	0°C to +70°C	5V ± 10%
Industrial	-40°C to +85°C	5V ± 10%
Military	-55°C to +125°C	5V ± 10%

**Electrical Characteristics Over the Operating Range (-8, -10, -12, -15)<sup>[3]</sup>**

Parameter	Description	Test Conditions	7C199-8		7C199-10		7C199-12		7C199-15		Unit	
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> = Min., I <sub>OH</sub> = -4.0 mA	2.4		2.4		2.4		2.4		V	
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> = Min., I <sub>OL</sub> = 8.0 mA		0.4		0.4		0.4		0.4	V	
V <sub>IH</sub>	Input HIGH Voltage		2.2	V <sub>CC</sub> + 0.3V	2.2	V <sub>CC</sub> + 0.3V	2.2	V <sub>CC</sub> + 0.3V	2.2	V <sub>CC</sub> + 0.3V	V	
V <sub>IL</sub>	Input LOW Voltage		-0.5	0.8	-0.5	0.8	-0.5	0.8	-0.5	0.8	V	
I <sub>IX</sub>	Input Load Current	GND ≤ V <sub>I</sub> ≤ V <sub>CC</sub>	-5	+5	-5	+5	-5	+5	-5	+5	μA	
I <sub>OZ</sub>	Output Leakage Current	GND ≤ V <sub>O</sub> ≤ V <sub>CC</sub> , Output Disabled	-5	+5	-5	+5	-5	+5	-5	+5	μA	
I <sub>CC</sub>	V <sub>CC</sub> Operating Supply Current	V <sub>CC</sub> = Max., I <sub>OUT</sub> = 0 mA, f = f <sub>MAX</sub> = 1/t <sub>RC</sub>	Com'l	120		110		160		155	mA	
			L			85		85		100	mA	
			Mil							180	mA	
I <sub>SB1</sub>	Automatic CE Power-down Current—TTL Inputs	Max. V <sub>CC</sub> , CE ≥ V <sub>IH</sub> , V <sub>IN</sub> ≥ V <sub>IH</sub> or V <sub>IN</sub> ≤ V <sub>IL</sub> , f = f <sub>MAX</sub>	Com'l	5		5		30		30	mA	
			L			5		5		5	mA	
I <sub>SB2</sub>	Automatic CE Power-down Current—CMOS Inputs	Max. V <sub>CC</sub> , CE ≥ V <sub>CC</sub> - 0.3V, V <sub>IN</sub> ≥ V <sub>CC</sub> - 0.3V or V <sub>IN</sub> ≤ 0.3V, f = 0	Com'l	0.5		0.5		10		10	mA	
			L		0.05		0.05		0.05		0.05	mA
			Mil							15	mA	

**Electrical Characteristics Over the Operating Range (-20, -25, -35, -45)<sup>[3]</sup>**

Parameter	Description	Test Conditions	7C199-20		7C199-25		7C199-35		7C199-45		Unit	
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> = Min., I <sub>OH</sub> = -4.0 mA	2.4		2.4		2.4		2.4		V	
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> = Min., I <sub>OL</sub> = 8.0 mA		0.4		0.4		0.4		0.4	V	
V <sub>IH</sub>	Input HIGH Voltage		2.2	V <sub>CC</sub> + 0.3V	2.2	V <sub>CC</sub> + 0.3V	2.2	V <sub>CC</sub> + 0.3V	2.2	V <sub>CC</sub> + 0.3V	V	
V <sub>IL</sub>	Input LOW Voltage		-0.5	0.8	-0.5	0.8	-0.5	0.8	-0.5	0.8	V	
I <sub>IX</sub>	Input Load Current	GND ≤ V <sub>I</sub> ≤ V <sub>CC</sub>	-5	+5	-5	+5	-5	+5	-5	+5	μA	
I <sub>OZ</sub>	Output Leakage Current	GND ≤ V <sub>I</sub> ≤ V <sub>CC</sub> , Output Disabled	-5	+5	-5	+5	-5	+5	-5	+5	μA	
I <sub>CC</sub>	V <sub>CC</sub> Operating Supply Current	V <sub>CC</sub> = Max., I <sub>OUT</sub> = 0 mA, f = f <sub>MAX</sub> = 1/t <sub>RC</sub>	Com'l	150		150		140		140	mA	
			L		90		80		70		70	mA
			Mil		170		150		150		150	mA

Shaded area contains advance information.

**Notes:**

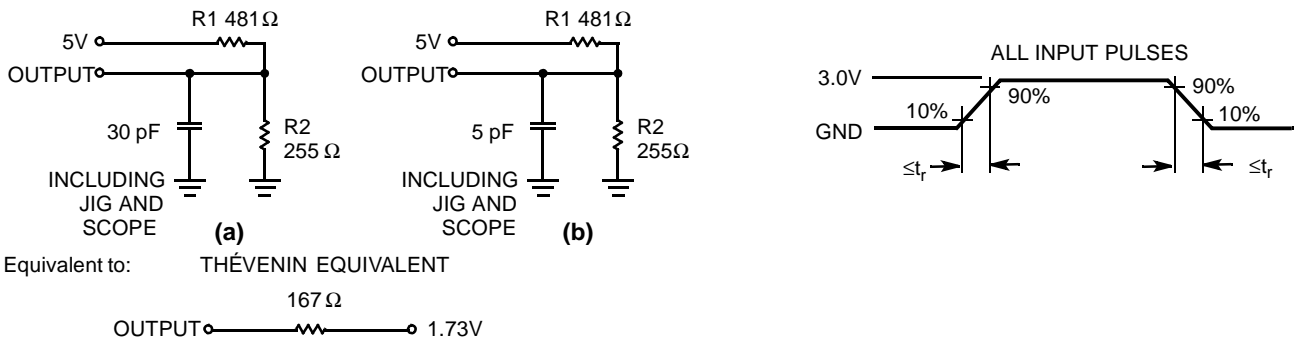
- V<sub>IL</sub> (min.) = -2.0V for pulse durations of less than 20 ns.
- T<sub>A</sub> is the "instant on" case temperature.
- See the last page of this specification for Group A subgroup testing information.

**Electrical Characteristics** Over the Operating Range (-20, -25, -35, -45) (continued)<sup>[3]</sup>

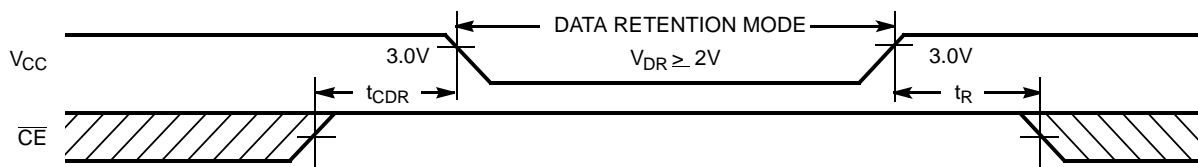
Parameter	Description	Test Conditions	7C199-20		7C199-25		7C199-35		7C199-45		Unit	
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
$I_{SB1}$	Automatic CE Power-down Current—TTL Inputs	Max. $V_{CC}$ , $\overline{CE} \geq V_{IH}$ , $V_{IN} \geq V_{IH}$ or $V_{IN} \leq V_{IL}$ , $f = f_{MAX}$	Com'l		30		30		25		25	mA
			L		5		5		5		5	mA
$I_{SB2}$	Automatic CE Power-down Current—CMOS Inputs	Max. $V_{CC}$ , $\overline{CE} \geq V_{CC} - 0.3V$ , $V_{IN} \geq V_{CC} - 0.3V$ or $V_{IN} \leq 0.3V$ , $f=0$	Com'l		10		10		10		10	mA
			L		0.05		0.05		0.05		0.05	$\mu A$
			Mil		15		15		15		15	mA

**Capacitance<sup>[4]</sup>**

Parameter	Description	Test Conditions	Max.	Unit
$C_{IN}$	Input Capacitance	$T_A = 25^\circ C$ , $f = 1$ MHz, $V_{CC} = 5.0V$	8	pF
$C_{OUT}$	Output Capacitance		8	pF

**AC Test Loads and Waveforms<sup>[5]</sup>**

**Data Retention Characteristics** Over the Operating Range (L-version only)

Parameter	Description	Conditions <sup>[6]</sup>	Min.	Max.	Unit
$V_{DR}$	$V_{CC}$ for Data Retention		2.0		V
$I_{CCDR}$	Data Retention Current	Com'l	$V_{CC} = V_{DR} = 2.0V$ , $\overline{CE} \geq V_{CC} - 0.3V$ , $V_{IN} \geq V_{CC} - 0.3V$ or $V_{IN} \leq 0.3V$		$\mu A$
		Com'l L		10	$\mu A$
$t_{CDR}$ <sup>[4]</sup>	Chip Deselect to Data Retention Time		0		ns
$t_R$ <sup>[5]</sup>	Operation Recovery Time		200		$\mu s$

**Data Retention Waveform**

**Note:**

4. Tested initially and after any design or process changes that may affect these parameters.
5.  $t_R \leq 3$  ns for the -12 and the -15 speeds.  $t_R \leq 5$  ns for the -20 and slower speeds
6. No input may exceed  $V_{CC} + 0.5V$ .

**Switching Characteristics** Over the Operating Range (-8, -10, -12, -15) [3, 7]

Parameter	Description	7C199-8		7C199-10		7C199-12		7C199-15		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Read Cycle</b>										
t <sub>RC</sub>	Read Cycle Time	8		10		12		15		ns
t <sub>AA</sub>	Address to Data Valid		8		10		12		15	ns
t <sub>OHA</sub>	Data Hold from Address Change	3		3		3		3		ns
t <sub>ACE</sub>	CE LOW to Data Valid		8		10		12		15	ns
t <sub>DOE</sub>	OE LOW to Data Valid		4.5		5		5		7	ns
t <sub>LZOE</sub>	OE LOW to Low-Z <sup>[8]</sup>	0		0		0		0		ns
t <sub>HZOE</sub>	OE HIGH to High-Z <sup>[8, 9]</sup>		5		5		5		7	ns
t <sub>LZCE</sub>	CE LOW to Low-Z <sup>[8]</sup>	3		3		3		3		ns
t <sub>HZCE</sub>	CE HIGH to High-Z <sup>[8,9]</sup>		4		5		5		7	ns
t <sub>PU</sub>	CE LOW to Power-up	0		0		0		0		ns
t <sub>PD</sub>	CE HIGH to Power-down		8		10		12		15	ns
<b>Write Cycle</b> <sup>[10, 11]</sup>										
t <sub>WC</sub>	Write Cycle Time	8		10		12		15		ns
t <sub>SCE</sub>	CE LOW to Write End	7		7		9		10		ns
t <sub>AW</sub>	Address Set-up to Write End	7		7		9		10		ns
t <sub>HA</sub>	Address Hold from Write End	0		0		0		0		ns
t <sub>SA</sub>	Address Set-up to Write Start	0		0		0		0		ns
t <sub>PWE</sub>	WE Pulse Width	7		7		8		9		ns
t <sub>SD</sub>	Data Set-up to Write End	5		5		8		9		ns
t <sub>HD</sub>	Data Hold from Write End	0		0		0		0		ns
t <sub>HZWE</sub>	WE LOW to High-Z <sup>[9]</sup>		5		6		7		7	ns
t <sub>LZWE</sub>	WE HIGH to Low-Z <sup>[8]</sup>	3		3		3		3		ns

**Switching Characteristics** Over the Operating Range (-20, -25, -35, -45)<sup>[3, 7]</sup>

Parameter	Description	7C199-20		7C199-25		7C199-35		7C199-45		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Read Cycle</b>										
t <sub>RC</sub>	Read Cycle Time	20		25		35		45		ns
t <sub>AA</sub>	Address to Data Valid		20		25		35		45	ns
t <sub>OHA</sub>	Data Hold from Address Change	3		3		3		3		ns
t <sub>ACE</sub>	CE LOW to Data Valid		20		25		35		45	ns
t <sub>DOE</sub>	OE LOW to Data Valid		9		10		16		16	ns
t <sub>LZOE</sub>	OE LOW to Low-Z <sup>[8]</sup>	0		0		0		0		ns
t <sub>HZOE</sub>	OE HIGH to High-Z <sup>[8, 9]</sup>		9		11		15		15	ns
t <sub>LZCE</sub>	CE LOW to Low-Z <sup>[8]</sup>	3		3		3		3		ns
t <sub>HZCE</sub>	CE HIGH to High-Z <sup>[8, 9]</sup>		9		11		15		15	ns
t <sub>PU</sub>	CE LOW to Power-up	0		0		0		0		ns

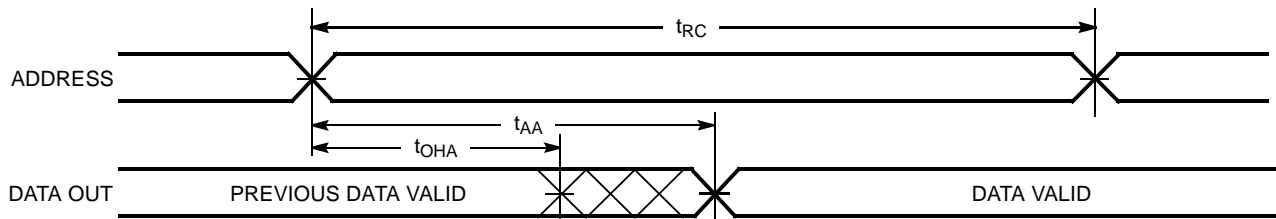
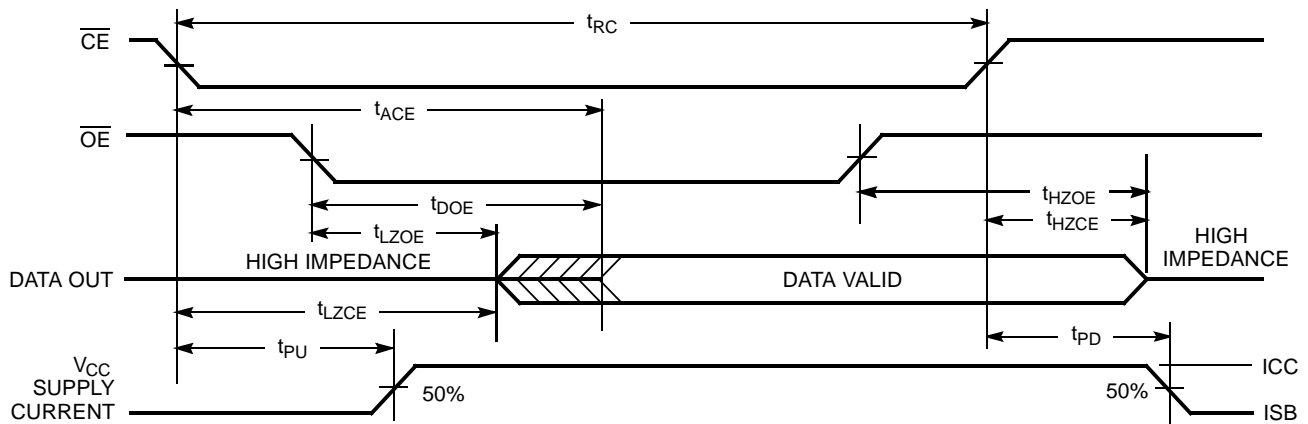
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**Notes:**

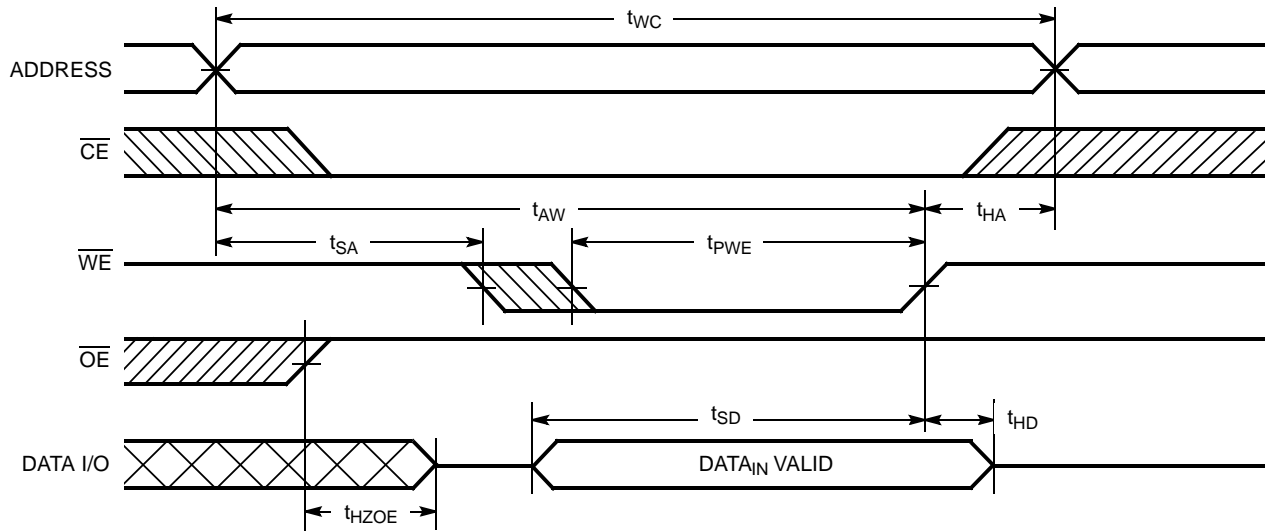
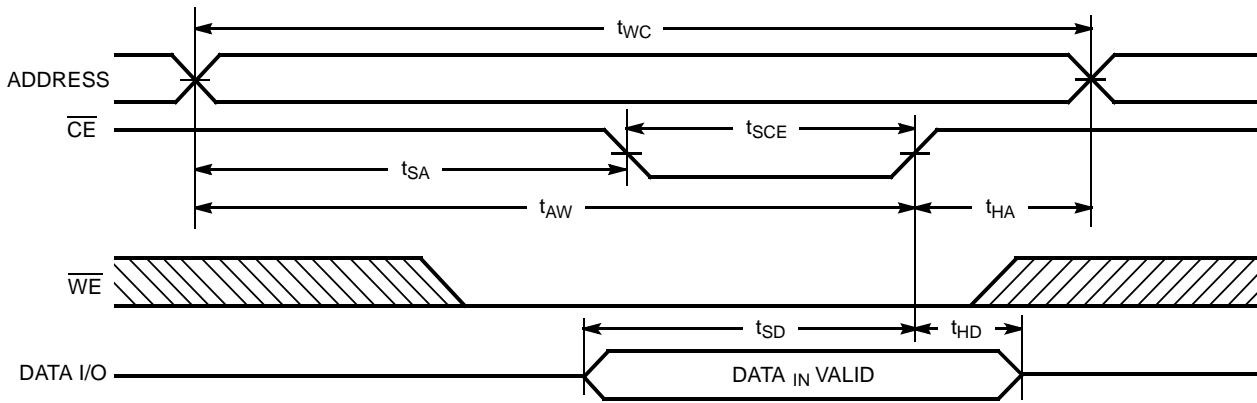
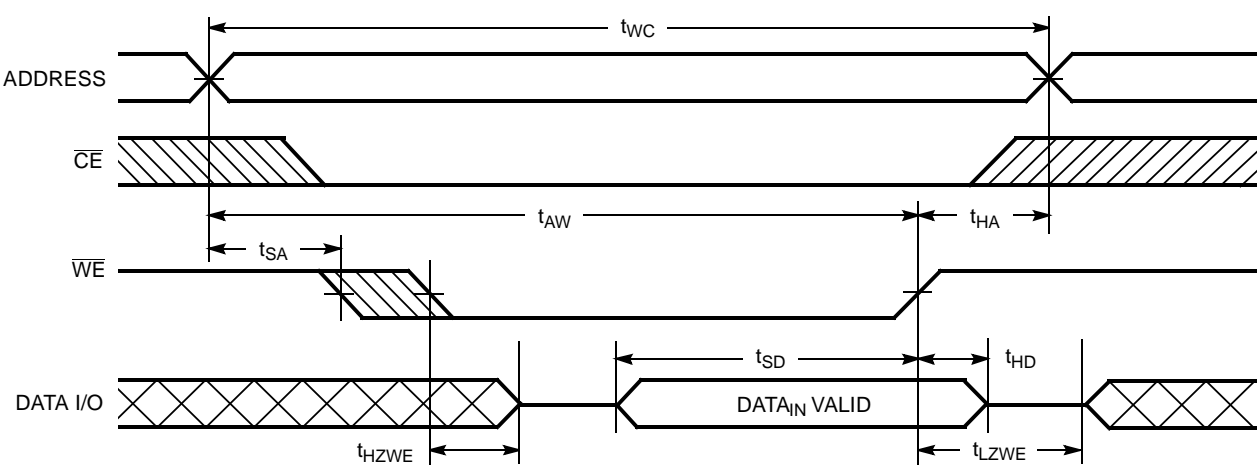
- Test conditions assume signal transition time of 3 ns or less for -12 and -15 speeds and 5 ns or less for -20 and slower speeds, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I<sub>OL</sub>/I<sub>OH</sub> and 30-pF load capacitance.
- At any given temperature and voltage condition, t<sub>HZCE</sub> is less than t<sub>OL</sub>/I<sub>OH</sub> and 30-pF load capacitance.
- t<sub>HZOE</sub>, t<sub>HZCE</sub>, and t<sub>HZWE</sub> are specified with C<sub>L</sub> = 5 pF as in part (b) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage.
- The internal write time of the memory is defined by the overlap of CE LOW and WE LOW. Both signals must be LOW to initiate a write and either signal can terminate a write by going HIGH. The data input set-up and hold timing should be referenced to the rising edge of the signal that terminates the write.
- The minimum write cycle time for write cycle #3 (WE controlled, OE LOW) is the sum of t<sub>HZWE</sub> and t<sub>SD</sub>.

**Switching Characteristics** Over the Operating Range (-20, -25, -35, -45)<sup>[3, 7]</sup>

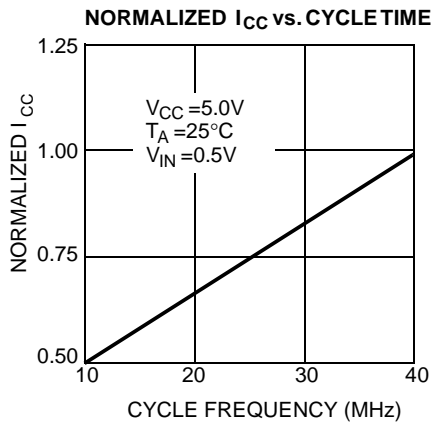
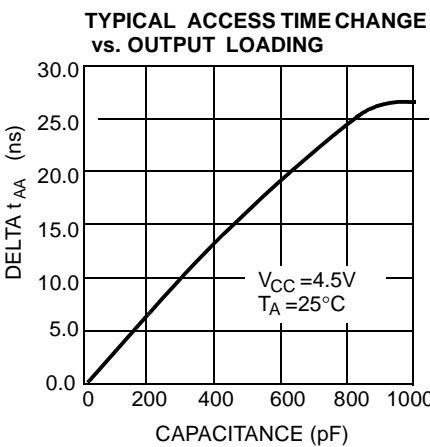
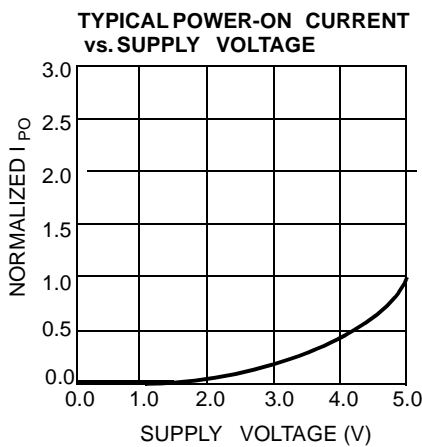
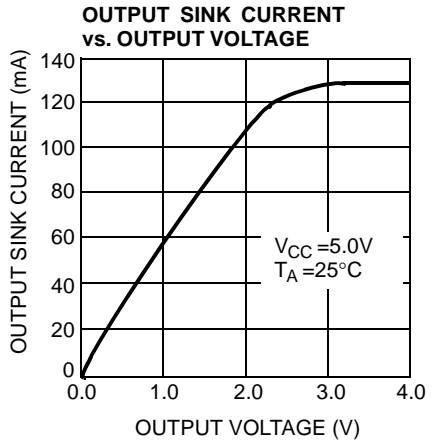
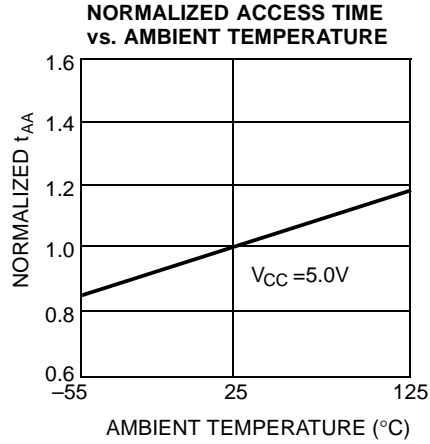
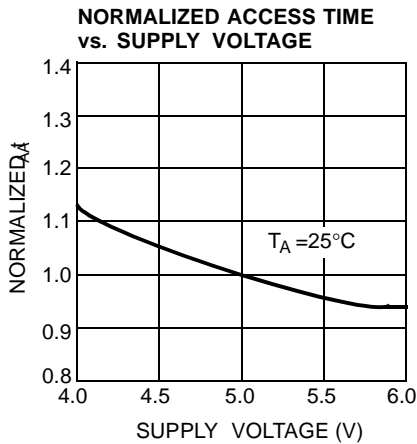
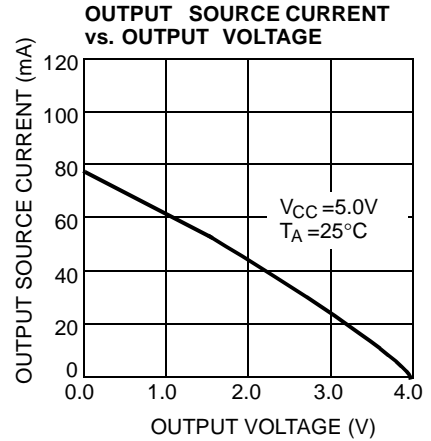
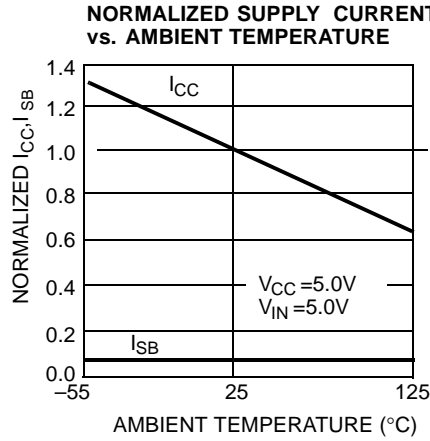
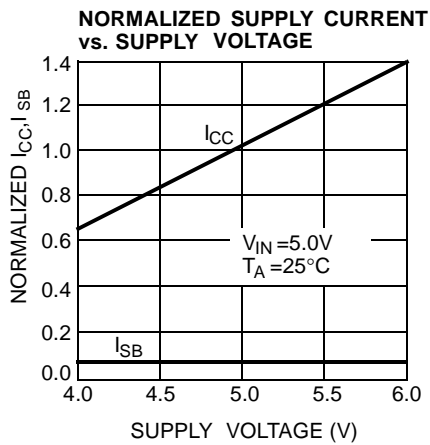
Parameter	Description	7C199-20		7C199-25		7C199-35		7C199-45		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
$t_{PD}$	CE HIGH to Power-down		20		20		20		25	ns
<b>Write Cycle<sup>[10,11]</sup></b>										
$t_{WC}$	Write Cycle Time	20		25		35		45		ns
$t_{SCE}$	CE LOW to Write End	15		18		22		22		ns
$t_{AW}$	Address Set-up to Write End	15		20		30		40		ns
$t_{HA}$	Address Hold from Write End	0		0		0		0		ns
$t_{SA}$	Address Set-up to Write Start	0		0		0		0		ns
$t_{PWE}$	WE Pulse Width	15		18		22		22		ns
$t_{SD}$	Data Set-up to Write End	10		10		15		15		ns
$t_{HD}$	Data Hold from Write End	0		0		0		0		ns
$t_{HZWE}$	WE LOW to High-Z <sup>[9]</sup>		10		11		15		15	ns
$t_{LZWE}$	WE HIGH to Low-Z <sup>[8]</sup>	3		3		3		3		ns

**Switching Waveforms**
**Read Cycle No. 1<sup>[12, 13]</sup>**

**Read Cycle No. 2<sup>[13, 14]</sup>**

**Notes:**

12. Device is continuously selected.  $\overline{OE}, \overline{CE} = V_{IL}$ .
13. WE is HIGH for read cycle.
14. Address valid prior to or coincident with  $\overline{CE}$  transition LOW.

**Switching Waveforms (continued)**
**Write Cycle No. 1 (WE Controlled)**<sup>[10, 15, 16]</sup>

**Write Cycle No. 2 (CE Controlled)**<sup>[10, 15, 16]</sup>

**Write Cycle No. 3 (WE Controlled  $\overline{OE}$  LOW)**<sup>[11, 16]</sup>

**Notes:**

15. Data I/O is high impedance if  $\overline{OE} = V_{IH}$ .
16. If  $\overline{CE}$  goes HIGH simultaneously with  $\overline{WE}$  HIGH, the output remains in a high-impedance state.

**Typical DC and AC Characteristics**

**Truth Table**

CE	WE	OE	Inputs/Outputs	Mode	Power
H	X	X	High Z	Deselect/Power-down	Standby ( $I_{SB}$ )
L	H	L	Data Out	Read	Active ( $I_{CC}$ )
L	L	X	Data In	Write	Active ( $I_{CC}$ )
L	H	H	High Z	Deselect, Output disabled	Active ( $I_{CC}$ )

**Ordering Information**

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range	
8	CY7C199-8VC	V21	28-Lead Molded SOJ	Commercial	
	CY7C199-8ZC	Z28	28-Lead Thin Small Outline Package		
	CY7C199L-8VC	V21	28-Lead Molded SOJ		
	CY7C199L-8ZC	Z28	28-Lead Thin Small Outline Package		
10	CY7C199-10VC	V21	28-Lead Molded SOJ	Commercial	
	CY7C199-10ZC	Z28	28-Lead Thin Small Outline Package		
	CY7C199L-10VC	V21	28-Lead Molded SOJ		
	CY7C199L-10ZC	Z28	28-Lead Thin Small Outline Package		
	CY7C199-10VI	V21	28-Lead Molded SOJ	Industrial	
	CY7C199-10ZI	Z28	28-Lead Thin Small Outline Package		
	CY7C199L-10VI	V21	28-Lead Molded SOJ		
	CY7C199L-10ZI	Z28	28-Lead Thin Small Outline Package		
12	CY7C199-12PC	P21	28-Lead (300-Mil) Molded DIP	Commercial	
	CY7C199-12VC	V21	28-Lead Molded SOJ		
	CY7C199-12ZC	Z28	28-Lead Thin Small Outline Package		
	CY7C199L-12PC	P21	28-Lead (300-Mil) Molded DIP		
	CY7C199L-12VC	V21	28-Lead Molded SOJ	Industrial	
	CY7C199L-12ZC	Z28	28-Lead Thin Small Outline Package		
	CY7C199-12VI	V21	28-Lead Molded SOJ		
	CY7C199-12ZI	Z28	28-Lead Thin Small Outline Package		
	CY7C199L-12VI	V21	28-Lead Molded SOJ		
	CY7C199L-12ZI	Z28	28-Lead Thin Small Outline Package		
15	CY7C199-15PC	P21	28-Lead (300-Mil) Molded DIP	Commercial	
	CY7C199-15VC	V21	28-Lead Molded SOJ		
	CY7C199-15ZC	Z28	28-Lead Thin Small Outline Package		
	CY7C199L-15PC	P21	28-Lead (300-Mil) Molded DIP		
	CY7C199L-15VC	V21	28-Lead Molded SOJ	Industrial	
	CY7C199L-15ZC	Z28	28-Lead Thin Small Outline Package		
	CY7C199-15VI	V21	28-Lead Molded SOJ		
	CY7C199-15ZI	Z28	28-Lead Thin Small Outline Package		
	CY7C199-15DMB	D22	28-Lead (300-Mil) CerDIP		Military
	CY7C199-15LMB	L54	28-Pin Rectangular Leadless Chip Carrier		
CY7C199L-15DMB	D22	28-Lead (300-Mil) CerDIP	Military		
CY7C199L-15LMB	L54	28-Pin Rectangular Leadless Chip Carrier			
20	CY7C199-20PC	P21	28-Lead (300-Mil) Molded DIP	Commercial	
	CY7C199-20VC	V21	28-Lead Molded SOJ		
	CY7C199-20ZC	Z28	28-Lead Thin Small Outline Package		
	CY7C199L-20PC	P21	28-Lead (300-Mil) Molded DIP		
	CY7C199L-20VC	V21	28-Lead Molded SOJ	Industrial	
	CY7C199L-20ZC	Z28	28-Lead Thin Small Outline Package		
	CY7C199-20VI	V21	28-Lead Molded SOJ		
	CY7C199-20ZI	Z28	28-Lead Thin Small Outline Package		
	CY7C199-20DMB	D22	28-Lead (300-Mil) CerDIP	Military	
	CY7C199-20LMB	L54	28-Pin Rectangular Leadless Chip Carrier		
	CY7C199L-20DMB	D22	28-Lead (300-Mil) CerDIP		
	CY7C199L-20LMB	L54	28-Pin Rectangular Leadless Chip Carrier		

Shaded area contains advance information. Contact your Cypress sales representative for availability

**Ordering Information** (continued)

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
25	CY7C199-25PC	P21	28-Lead (300-Mil) Molded DIP	Commercial
	CY7C199-25SC	S21	28-Lead Molded SOIC	
	CY7C199-25VC	V21	28-Lead Molded SOJ	
	CY7C199-25ZC	Z28	28-Lead Thin Small Outline Package	Industrial
	CY7C199-25SI	S21	28-Lead Molded SOIC	
	CY7C199-25VI	V21	28-Lead Molded SOJ	
	CY7C199-25ZI	Z28	28-Lead Thin Small Outline Package	Military
	CY7C199-25DMB	D22	28-Lead (300-Mil) CerDIP	
	CY7C199-25LMB	L54	28-Pin Rectangular Leadless Chip Carrier	
35	CY7C199-35PC	P21	28-Lead (300-Mil) Molded DIP	Commercial
	CY7C199-35SC	S21	28-Lead Molded SOIC	
	CY7C199-35VC	V21	28-Lead Molded SOJ	
	CY7C199-35ZC	Z28	28-Lead Thin Small Outline Package	Industrial
	CY7C199-35SI	S21	28-Lead Molded SOIC	
	CY7C199-35VI	V21	28-Lead Molded SOJ	
	CY7C199-35ZI	Z28	28-Lead Thin Small Outline Package	Military
	CY7C199-35DMB	D22	28-Lead (300-Mil) CerDIP	
	CY7C199-35LMB	L54	28-Pin Rectangular Leadless Chip Carrier	
45	CY7C199-45DMB	D22	28-Lead (300-Mil) CerDIP	Military
	CY7C199-45LMB	L54	28-Pin Rectangular Leadless Chip Carrier	

Shaded area contains advance information. Contact your Cypress sales representative for availability

**MILITARY SPECIFICATIONS**
**Group A Subgroup Testing**
**DC Characteristics**

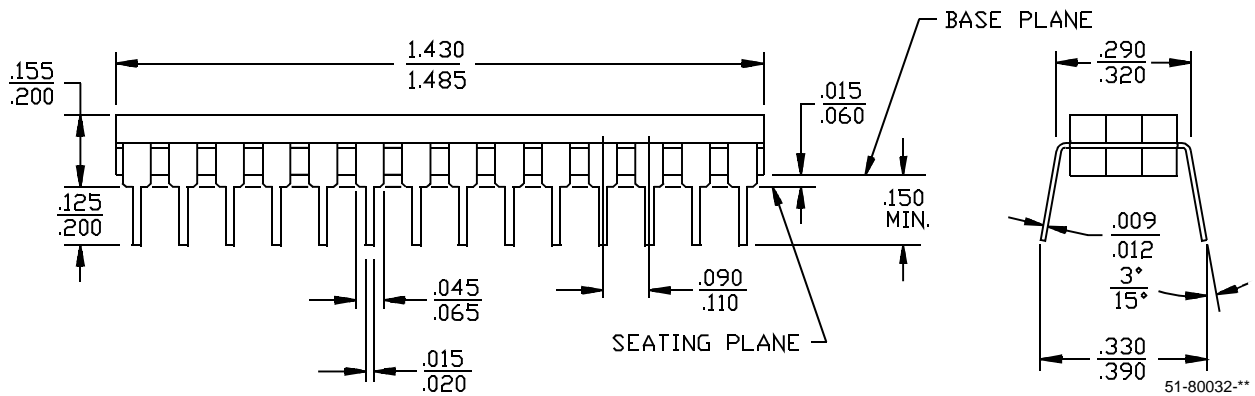
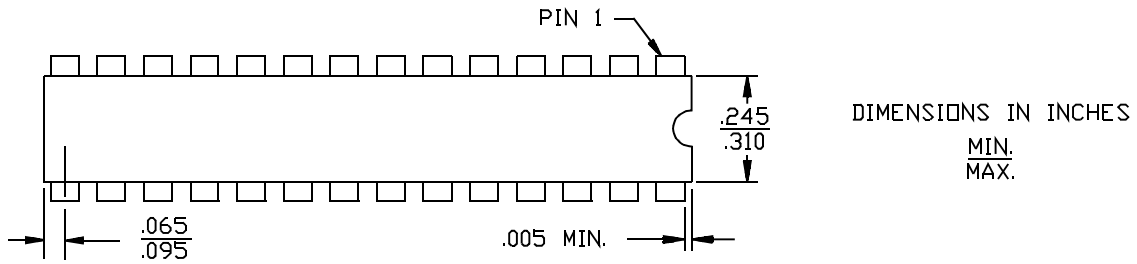
Parameter	Subgroups
$V_{OH}$	1, 2, 3
$V_{OL}$	1, 2, 3
$V_{IH}$	1, 2, 3
$V_{IL}$ Max.	1, 2, 3
$I_{IX}$	1, 2, 3
$I_{OZ}$	1, 2, 3
$I_{CC}$	1, 2, 3
$I_{SB1}$	1, 2, 3
$I_{SB2}$	1, 2, 3

**Switching Characteristics**

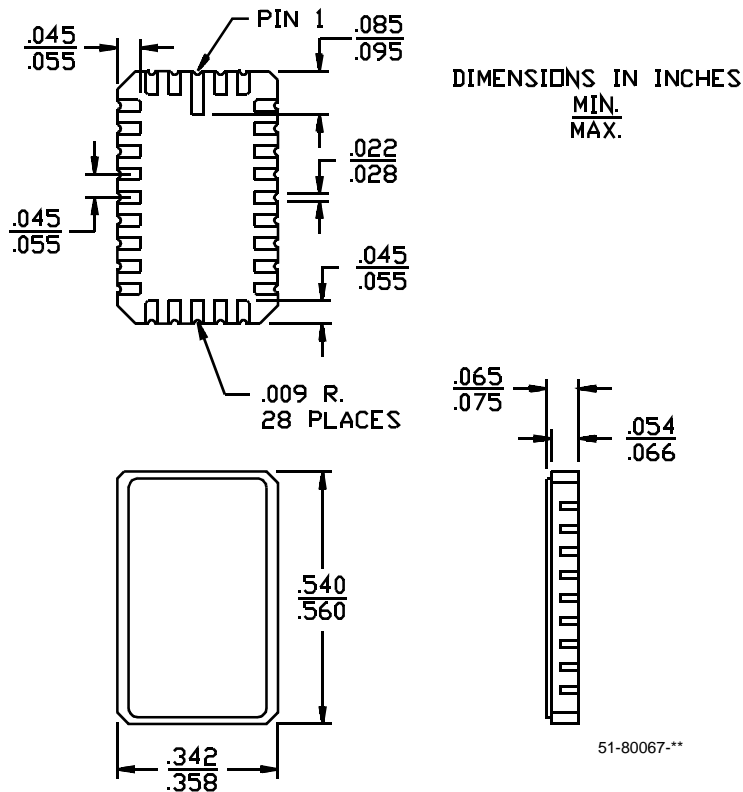
Parameter	Subgroups
<b>Read Cycle</b>	
$t_{RC}$	7, 8, 9, 10, 11
$t_{AA}$	7, 8, 9, 10, 11
$t_{OHA}$	7, 8, 9, 10, 11
$t_{ACE}$	7, 8, 9, 10, 11
$t_{DOE}$	7, 8, 9, 10, 11
<b>Write Cycle</b>	
$t_{WC}$	7, 8, 9, 10, 11
$t_{AA}$	7, 8, 9, 10, 11
$t_{AW}$	7, 8, 9, 10, 11
$t_{HA}$	7, 8, 9, 10, 11
$t_{SA}$	7, 8, 9, 10, 11
$t_{PWE}$	7, 8, 9, 10, 11
$t_{SD}$	7, 8, 9, 10, 11
$t_{HD}$	7, 8, 9, 10, 11

Package Diagrams

**28-pin (300-Mil) CerDIP D22**  
MIL-STD-1835 D-15 Config. A

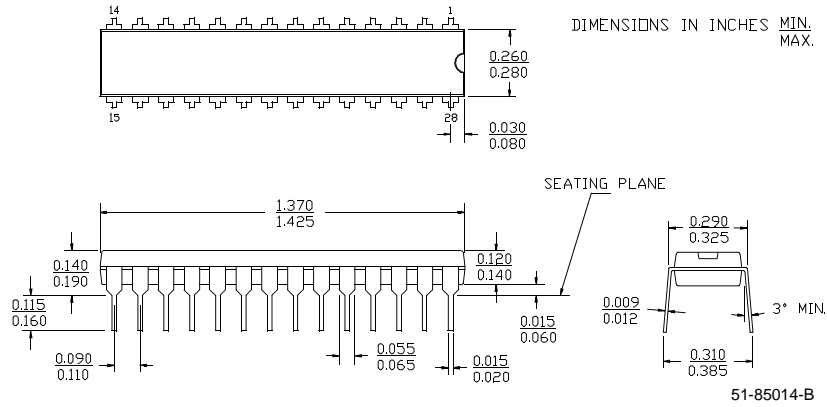


**28-pin Rectangular Leadless Chip Carrier L54**  
MIL-STD-1835C-11A

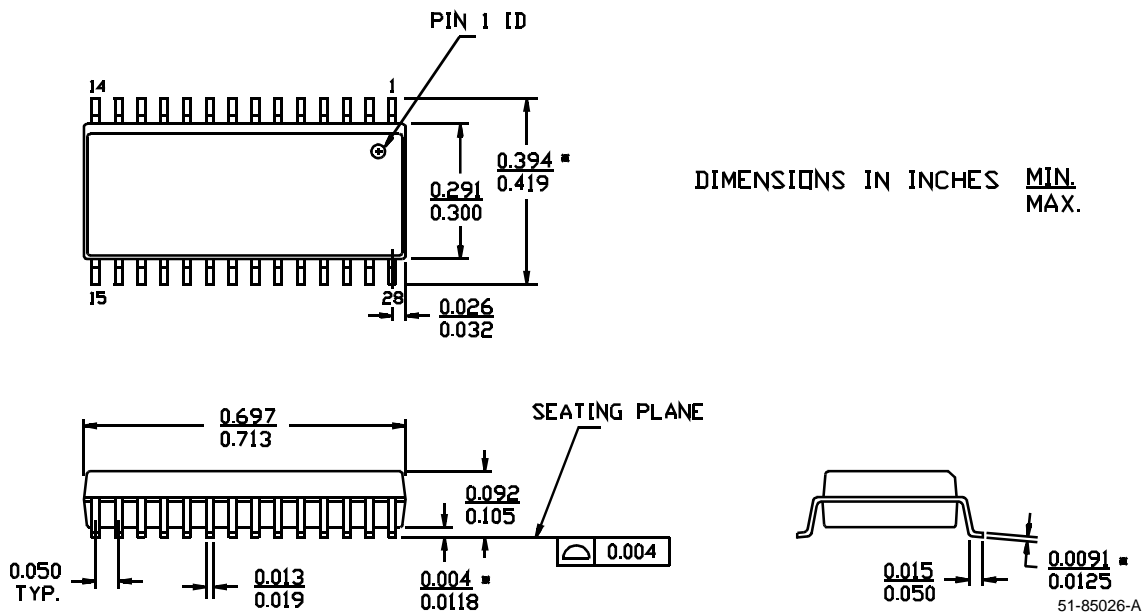


Package Diagrams (continued)

28-pin (300-Mil) Molded DIP P21

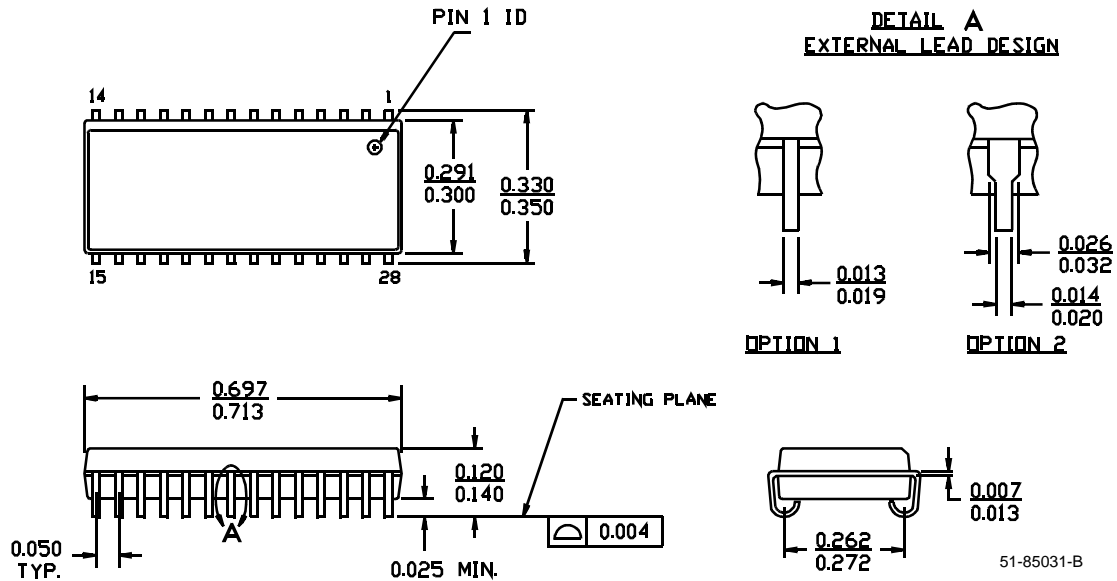


28-pin (300-Mil) Molded SOIC S21



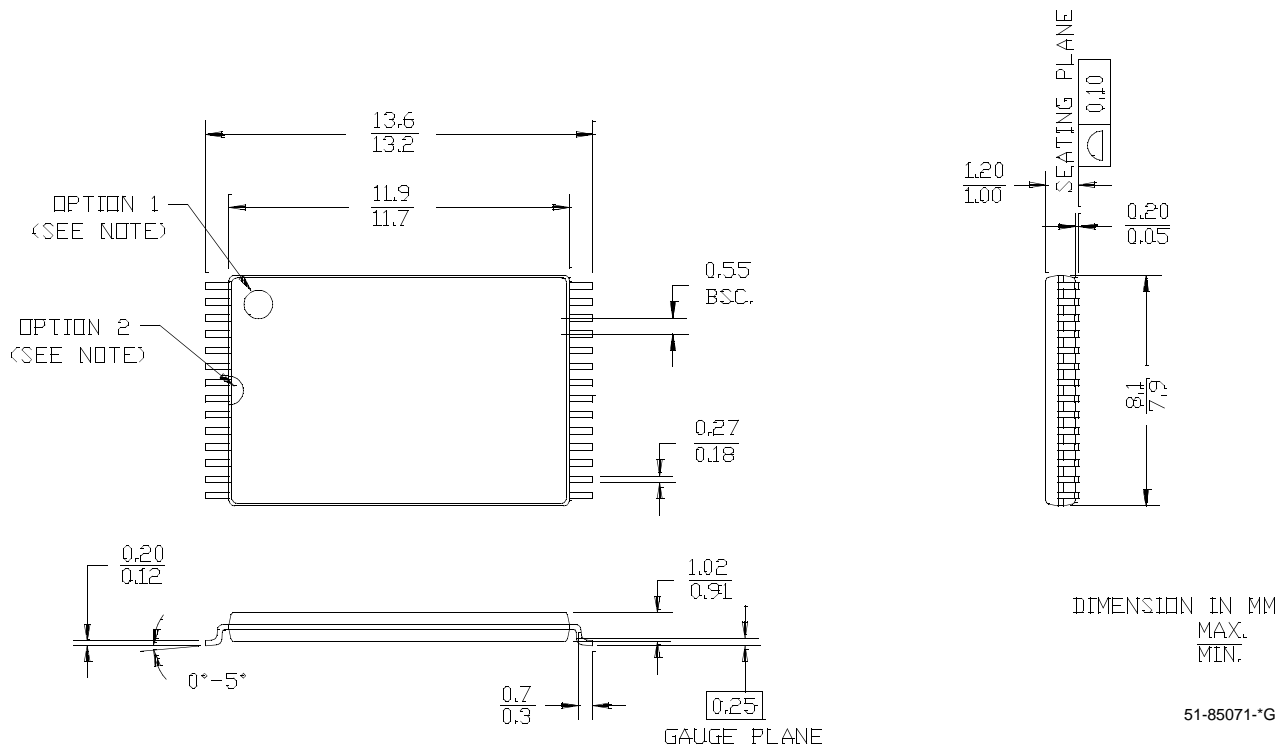
**Package Diagrams** (continued)

28-pin (300-Mil) Molded SOJ V21  
 DIMENSIONS IN INCHES    MIN.    MAX.



**28-Lead Thin Small Outline Package Type 1 (8x13.4 mm) Z28**

NOTE: ORIENTATION I.D. MAY BE LOCATED EITHER AS SHOWN IN OPTION 1 OR OPTION 2



DIMENSION IN MM  
 MAX.  
 MIN.

51-85071-G

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**Document History Page**

<b>Document Title: CY7C199 32K x 8 Static RAM</b> <b>Document Number: 38-05160</b>				
<b>REV.</b>	<b>ECN NO.</b>	<b>Issue Date</b>	<b>Orig. of Change</b>	<b>Description of Change</b>
**	109971	10/28/01	SZV	Change from Spec number: 38-00239 to 38-05160
*A	121730	01/09/02	DFP	Updated Product Offering table.



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